2SD2258

Silicon NPN epitaxial planar type

For low-frequency output amplification

■ Features

- Darlington connection
- High forward current transfer ratio h_{FE}
- Allowing supply with the radial taping

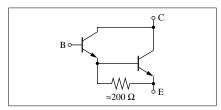
■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol Rating		Unit	
Collector to base voltage	V_{CBO}	60	V	
Collector to emitter voltage	V _{CEO}	50	V	
Emitter to base voltage	V_{EBO}	5	V	
Peak collector current	I_{CP}	1.5	A	
Collector current	I_{C}	1	A	
Collector power dissipation *	P_{C}	1	W	
Junction temperature	T _j	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	

Note) *: Printed circuit board: Copper foil area of 1cm² or more, and the board thickness of 1.7 mm for the collector portion

Unit: mm 0.7 4.0 2.5±0.1 0.65 max. 0.45±0.10 1.05±0.05 1. Emitter 2: Collector 1 2 3 3: Base MT-2-Al Package

Internal Connection



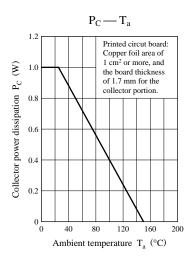
■ Electrical Characteristics $T_a = 25$ °C

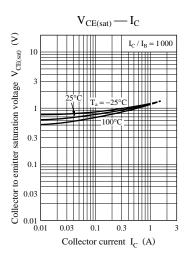
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = 45 \text{ V}, I_E = 0$			0.1	μΑ
Emitter cutoff current	I _{EBO}	$V_{EB} = 4 \text{ V}, I_C = 0$			0.1	μΑ
Collector to base voltage	V _{CBO}	$I_C = 100 \ \mu A, I_E = 0$	60			V
Collector to emitter voltage	V _{CEO}	$I_C = 1 \text{ mA}, I_B = 0$	50			V
Emitter to base voltage	V_{EBO}	$I_E = 100 \ \mu A, I_C = 0$	5			V
Forward current transfer ratio *2	h _{FE}	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ A}$	4000		40 000	
Collector to emitter saturation voltage *1	V _{CE(sat)}	$I_C = 1 A, I_B = 1 mA$			1.8	V
Base to emitter saturation voltage *1	V _{BE(sat)}	$I_C = 1 A$, $I_B = 1 mA$			2.2	V
Transition frequency	f_T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		150		MHz

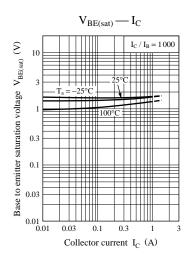
Note) *1: Pulse measurement

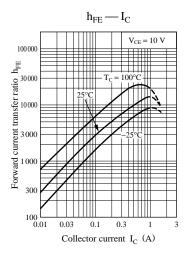
^{*2:} h_{FE} Rank classification

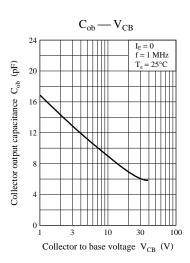
Rank	Q	R	S
h_{FE}	4 000 to 10 000	8 000 to 20 000	16000 to 40000











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